

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	19	(US-20010047222-\$ or US-20020044266-\$ or US-20020116083-\$ or US-20030233161-\$ or US-20040049398-\$ or US-20040088068-\$ or US-20040214097-\$).did. or (US-5751581-\$ or US-5834915-\$ or US-5841660-\$ or US-6148307-\$ or US-6240335-\$ or US-6366824-\$ or US-6529789-\$ or US-6603529-\$ or US-6618640-\$ or US-6725113-\$ or US-6748287-\$ or US-6760640-\$). did.	US-PGPUB; USPAT	OR	OFF	2005/02/25 14:41
L2	4	I1 and mask and customer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 14:42
L3	1	"6466945".pn.	US-PGPUB; USPAT	OR	OFF	2005/02/25 14:41
L4	9	I1 and customer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:02
L5	1336	700/115,121.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:02
L6	395	I5 and (mask or photomask)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:15
L7	40	I6 and customer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:03
L8	0	I7 and alter same sate	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:02
L9	1	I7 and alter same state	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:03
L10	336139	700/229.ccls. (mask or photomask)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:15
L11	6	700/229.ccls. and (mask or photomask)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:18
L12	741	716/19.ccls. and (mask or photomask)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:18

L13	43	l12 and customer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:18
L14	8	l13 and track\$4	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/02/25 15:18
S1	1	"6537844".pn.	US-PGPUB; USPAT	OR	ON	2004/10/29 15:40
S2	367	mask and semiconductor and track and state adj diagram	US-PGPUB; USPAT	OR	ON	2004/09/09 13:52
S3	0	(mask and semiconductor and track and state adj diagram) and virtual adj fab	US-PGPUB; USPAT	OR	ON	2004/09/09 13:51
S4	87	(mask and semiconductor and track and state adj diagram) and virtual	US-PGPUB; USPAT	OR	ON	2004/09/09 13:51
S5	14	((mask and semiconductor and track and state adj diagram) and virtual) and future same location	US-PGPUB; USPAT	OR	ON	2004/09/09 13:51
S6	0	mask same lithographic and semiconductor and track and state adj diagram	US-PGPUB; USPAT	OR	ON	2004/09/09 13:52
S7	13	mask same semiconductor and track and state adj diagram	US-PGPUB; USPAT	OR	ON	2004/09/09 13:52
S8	5	"5834915".URPN.	USPAT	OR	ON	2004/09/09 13:57
S9	1	"6537844".pn.	US-PGPUB; USPAT	OR	ON	2004/10/22 14:37
S10	648	semiconductor and mask and future SAME location	US-PGPUB; USPAT	OR	ON	2004/10/22 14:41
S11	65	(semiconductor and mask and future SAME location ) and fab	US-PGPUB; USPAT	OR	ON	2004/10/22 14:41
S12	5	((semiconductor and mask and future SAME location ) and fab) and reticle	US-PGPUB; USPAT	OR	ON	2004/10/22 14:43
S13	50	((semiconductor and mask and future SAME location ) and fab) and track\$3	US-PGPUB; USPAT	OR	ON	2004/10/22 14:44
S14	52	(reticle or mask) same track\$3 and fab	US-PGPUB; USPAT	OR	ON	2004/10/22 14:47
S15	47	((reticle or mask) same track\$3 and fab) and process) and location	US-PGPUB; USPAT	OR	ON	2004/10/22 14:48
S16	52	((reticle or mask) same track\$3 and fab) and process	US-PGPUB; USPAT	OR	ON	2004/10/22 15:10
S17	82	kosowski.xa.	US-PGPUB; USPAT	OR	ON	2004/10/22 15:30
S18	185	700/115.ccls.	US-PGPUB; USPAT	OR	ON	2004/10/22 15:30

S19	0	700/115.ccls. and virtual same fab	US-PGPUB; USPAT	OR	ON	2004/10/22 15:30
S20	72	700/115.ccls. and tracking	US-PGPUB; USPAT	OR	ON	2004/10/22 15:31
S21	25	(700/115.ccls. and tracking) and (semiconductor or reticle or mask)	US-PGPUB; USPAT	OR	ON	2004/10/22 15:41
S22	1	virtual adj fab	US-PGPUB; USPAT	OR	ON	2004/10/22 15:41
S23	545	semiconductor and track same predict\$4	US-PGPUB; USPAT	OR	ON	2004/10/22 16:15
S24	15	state adj diagram and reticle	US-PGPUB; USPAT	OR	ON	2004/10/22 16:18
S25	1685	state adj diagram and mask	US-PGPUB; USPAT	OR	ON	2004/10/22 16:18
S26	413	(state adj diagram and mask) and semiconductor and track\$3	US-PGPUB; USPAT	OR	ON	2004/10/22 16:19
S27	32	((state adj diagram and mask) and semiconductor and track\$3) and fab	US-PGPUB; USPAT	OR	ON	2004/10/22 16:35
S28	8	enterprise same mask same management	US-PGPUB; USPAT	OR	ON	2004/10/22 16:55
S29	7	700/115.ccls. and enterprise	US-PGPUB; USPAT	OR	ON	2004/10/22 16:58
S30	4	virtual adj fabrication	US-PGPUB; USPAT	OR	ON	2004/10/22 16:58
S31	15	state adj diagram and reticle	US-PGPUB; USPAT	OR	ON	2004/10/25 11:53
S32	115	"700"/\$.ccls. and track same semiconductor	US-PGPUB; USPAT	OR	ON	2004/10/27 16:38
S33	26	("700"/\$.ccls. and track same semiconductor) and customer	US-PGPUB; USPAT	OR	ON	2004/10/27 16:38
S34	14	((("700"/\$.ccls. and track same semiconductor) and customer) and fabrication	US-PGPUB; USPAT	OR	ON	2004/10/27 16:43
S35	1339	700/115,121,222,229.ccls.	US-PGPUB; USPAT	OR	ON	2004/10/27 16:39
S36	167	700/115,121,222,229.ccls. and reticle	US-PGPUB; USPAT	OR	ON	2004/10/29 15:44
S37	28	(700/115,121,222,229.ccls. and reticle) and station and track\$4	US-PGPUB; USPAT	OR	ON	2004/10/27 16:45
S38	1	"6760640".pn.	US-PGPUB; USPAT	OR	ON	2004/10/27 16:48
S39	1	"6148307".pn.	US-PGPUB; USPAT	OR	ON	2004/10/27 16:48
S40	4	virtual adj fabrication	US-PGPUB; USPAT	OR	ON	2004/10/29 15:41

S41	1	virtual adj fab	US-PGPUB; USPAT	OR	ON	2004/10/29 15:42
S42	632	lithograph\$3 and virtual and track\$3	US-PGPUB; USPAT	OR	ON	2004/10/29 15:42
S43	21	(lithograph\$3 and virtual and track\$3) and enterprise	US-PGPUB; USPAT	OR	ON	2004/10/29 15:42
S44	363	700/115,121,222,229.ccls. and mask	US-PGPUB; USPAT	OR	ON	2004/10/29 15:44
S45	6	700/115,121,222,229.ccls. and lithographic adj mask	US-PGPUB; USPAT	OR	ON	2004/10/29 15:44
S46	0	track with lithographic adj mask	US-PGPUB; USPAT	OR	ON	2004/10/29 15:44
S47	5	track same lithographic adj mask	US-PGPUB; USPAT	OR	ON	2004/10/29 15:45
S48	11	track\$3 same lithographic adj mask	US-PGPUB; USPAT	OR	ON	2004/10/29 15:45
S49	205	track\$3 same mask same semiconductor	US-PGPUB; USPAT	OR	ON	2004/10/29 15:45
S50	6	(track\$3 same mask same semiconductor) and virtual	US-PGPUB; USPAT	OR	ON	2004/10/29 15:46
S51	12	(track\$3 same mask same semiconductor) and customer	US-PGPUB; USPAT	OR	ON	2004/10/29 15:47
S52	1080	(semiconductor or wafer or substrate) same track\$3 and virtual	US-PGPUB; USPAT	OR	ON	2004/10/29 15:48
S53	27	((semiconductor or wafer or substrate) same track\$3 and virtual) and future same location	US-PGPUB; USPAT	OR	ON	2004/10/29 15:47
S54	885	(semiconductor or wafer or substrate) same track\$3 and customer	US-PGPUB; USPAT	OR	ON	2004/10/29 15:49
S55	752	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)	US-PGPUB; USPAT	OR	ON	2004/10/29 15:49
S56	365	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer	US-PGPUB; USPAT	OR	ON	2004/10/29 15:49
S57	239	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer) and interface	US-PGPUB; USPAT	OR	ON	2004/10/29 15:49
S58	29	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer) and interface) and enterprise	US-PGPUB; USPAT	OR	ON	2004/10/29 15:49

S59	19	(US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$). did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.	US-PGPUB; USPAT	OR	OFF	2004/11/01 14:43
S60	10	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$). did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and customer	US-PGPUB; USPAT	OR	ON	2004/11/01 14:43
S61	5	((((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$). did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and customer) and MES	US-PGPUB; USPAT	OR	ON	2004/11/01 15:18
S62	0	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$). did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and team	US-PGPUB; USPAT	OR	ON	2004/11/01 15:18

S63	14	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$). did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and operator	US-PGPUB; USPAT	OR	ON	2004/11/01 15:20
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